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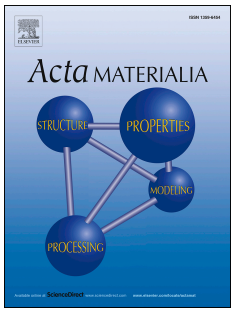


High thermoelectric performance of melt-spun $Cu_xBi_{0.5}Sb_{1.5}Te_3$ by synergetic effect of carrier tuning and phonon engineering

Jeong Seop Yoon, Jae Min Song, Jamil Ur Rahman, Soonil Lee, Won Seon Seo, Kyu Hyoung Lee, Seyun Kim, Hyun-Sik Kim, Sang-il Kim, Weon Ho Shin

PII: S1359-6454(18)30607-4

DOI: 10.1016/j.actamat.2018.07.067

Reference: AM 14744

To appear in: *Acta Materialia*

Received Date: 21 March 2018

Revised Date: 27 July 2018

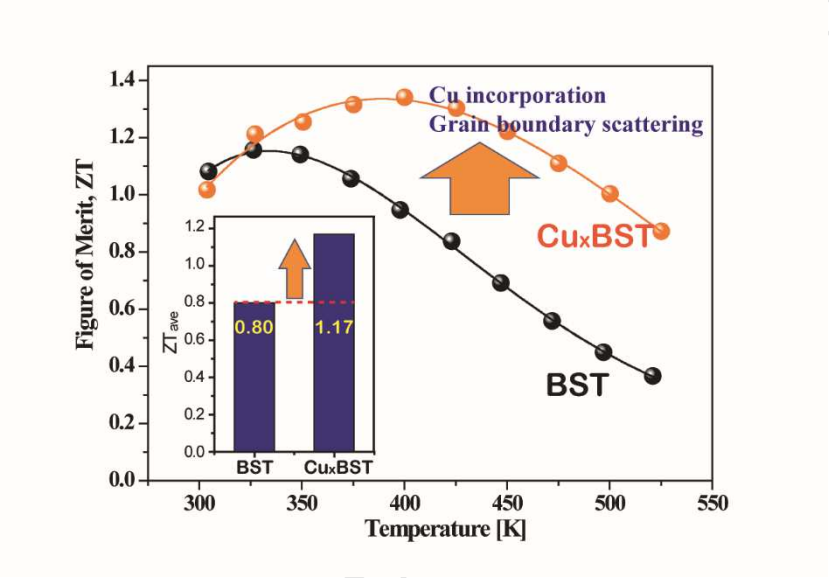
Accepted Date: 27 July 2018

Please cite this article as: J.S. Yoon, J.M. Song, J.U. Rahman, S. Lee, W.S. Seo, K.H. Lee, S. Kim, H.-S. Kim, S.-i. Kim, W.H. Shin, High Thermoelectric Performance of Melt-spun $Cu_xBi_{0.5}Sb_{1.5}Te_3$ by Synergetic Effect of Carrier Tuning and Phonon Engineering, *Acta Materialia* (2018), doi: 10.1016/j.actamat.2018.07.067.

Graphical Abstract

High Thermoelectric Performance of Melt-spun $Cu_xBi_{0.5}Sb_{1.5}Te_3$ by Synergetic Effect of Carrier Tuning and Phonon Engineering

Jeong Seop Yoon,[a,+] Jae Min Song,[a,+] Jamil Ur Rahman,[a] Soonil Lee,[b] Won Seon Seo,[a] Kyu Hyoung Lee,[c] Seyun Kim,[d] Hyun-Sik Kim,[e] Sang-il Kim,[f,] Weon Ho Shin [a,*]*



The combined effect of melt-spinning process and Cu incorporation gives to widen Bi-Te-based thermoelectric materials for mid-temperature power generation